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Phase Control Thyristors (Hockey PUK Version), 350 A



TO-200AB (A-PUK)

PRODUCT SUMMARY					
Package	TO-200AB (A-PUK)				
Diode variation	Single SCR				
I _{T(AV)}	350 A				
V _{DRM} /V _{RRM}	400 V to 2000 V				
V _{TM}	1.96 V				
I _{GT}	150 mA				
TJ	-40 °C to 125 °C				

FEATURES

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
1		350	А			
I _{T(AV)}	T _{hs}	55	°C			
1		660	А			
I _{T(RMS)}	T _{hs}	25	°C			
I _{TSM}	50 Hz	5000				
	60 Hz	5230	— A			
l ² t	50 Hz	125	kA ² s			
	60 Hz	114	KA2S			
V _{DRM} /V _{RRM}		400 to 2000	V			
tq	Typical	100	μs			
TJ		-40 to 125	°C			

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	I_{DRM}/I_{RRM} MAXIMUM AT T _J = T _J MAXIMUM mA				
	04	400	500					
	08	800	900					
VS-ST180CC	12	1200	1300	30				
V3-3118000	16	1600	1700	30				
	18	1800	1900					
	20	2000	2100					

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ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum average on-state current	1	180° condu	180° conduction, half sine wave		350 (140)	A
at heatsink temperature	I _{T(AV)}	double side	(single side) co	oled	55 (85)	°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 25 °C	heatsink temp	erature double side cooled	660	
		t = 10 ms	No voltage		5000	
Maximum peak, one-cycle	l	t = 8.3 ms	reapplied		5230	A
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		4200	
		t = 8.3 ms	reapplied	Sinusoidal half wave,	4400]
Marine 12 for fortun		t = 10 ms	No voltage reapplied 100 % V _{BBM}	initial $T_J = T_J$ maximum	125	kA ² s
	l ² t	t = 8.3 ms			114	
Maximum I ² t for fusing		t = 10 ms			88	
		t = 8.3 ms	reapplied		81	
Maximum I ² \sqrt{t} for fusing	l²√t	t = 0.1 to 10) ms, no voltage	e reapplied	1250	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x \ I_{T(AV)} < I < \pi \ x$	$I_{T(AV)}$), $T_J = T_J$ maximum	1.08	v
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$(I > \pi x I_{T(AV)}), T_J = T_J maximum$			v
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), T _J = T _J maximum			1.18	mΩ
High level value of on-state slope resistance	r _{t2}	$(I > \pi x I_{T(AV)}), T_J = T_J maximum$			1.14	1115.2
Maximum on-state voltage	V _{TM}	$I_{pk} = 750 \text{ A}, T_J = T_J \text{ maximum, } t_p = 10 \text{ ms sine pulse}$			1.96	V
Maximum holding current	Ι _Η	T 05 10 sector of 10 V sector shart		600	mA	
Maximum (typical) latching current	١L	T _J = 25 °C, anode supply 12 V resistive load 1000 (1000 (300)	IIIA	

SWITCHING							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 $\Omega,t_r \leq 1~\mu s$ T_J = T_J maximum, anode voltage $\leq 80~\%~V_{DRM}$	1000	A/µs			
Typical delay time	t _d	Gate current 1 A, dl _g /dt = 1 A/ μ s V _d = 0.67 % V _{DRM} , T _J = 25 °C	1.0				
Typical turn-off time	tq	I_{TM} = 300 A, T_J = T_J maximum, dl/dt = 20 A/µs, V_R = 50 V, dV/dt = 20 V/µs, gate 0 V 100 $\Omega,$ t_p = 500 µs	100	μs			

BLOCKING							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNIT S			
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated V_{DRM}	500	V/µs			
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	30	mA			

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TRIGGERING						
PARAMETER	SYMBOL		TEST CONDITIONS			UNIT
FARAMETER	STMDOL	•	lest conditions	typ.	max.	S
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	, $t_p \le 5 \text{ ms}$	10		w
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	, f = 50 Hz, d% = 50	2	.0	vv
Maximum peak positive gate current	I _{GM}			3	.0	А
Maximum peak positive gate voltage	+ V _{GM}	$T_J = T_J$ maximum, $t_p \le 5$ ms 20		20	v	
Maximum peak negative gate voltage	- V _{GM}				5.0	
	I _{GT}	T _J = - 40 °C		180	-	
DC gate current required to trigger		T _J = 25 °C		90	150	mA
		T _J = 125 °C	Maximum required gate trigger/ current/voltage are the lowest value	40	-	
		T _J = - 40 °C	which will trigger all units 12 V anode to cathode applied	2.9	-	
DC gate voltage required to trigger	V _{GT}	T _J = 25 °C	anode to cathode applied	1.8	3.0	V
		T _J = 125 °C		1.2	-	1
DC gate current not to trigger	I _{GD}	т. т	Maximum gate current/voltage not to trigger is the maximum value	1	0	mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J maximum$	which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.25		v

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNIT S		
Maximum operating junction temperature range	TJ		-40 to 125	°C		
Maximum storage temperature range	T _{Stg}		-40 to 150			
Maximum thermal resistance, junction to heatsink	R _{thJ-hs}	DC operation single side cooled	0.17			
		DC operation double side cooled	0.08	K/W		
Maximum thermal resistance,		DC operation single side cooled	0.033	- r./ vv		
case to heatsink	R _{thC-hs}	DC operation double side cooled	0.017	1		
Mounting force, ± 10 %			4900 (500)	N (kg)		
Approximate weight			50	g		
Case style		See dimensions - link at the end of datasheet	TO-200AB (A	A-PUK)		



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$\Delta \mathbf{R}_{thJC}$	CONDUCTION

CONDUCTION ANGLE		SINUSOIDAL CONDUCTION		NGULAR JCTION	TEST CONDITIONS	UNITS	
	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE			
180°	0.015	0.015	0.011	0.011			
120°	0.018	0.019	0.019	0.019			
90°	0.024	0.024	0.026	0.026	$T_J = T_J$ maximum	K/W	
60°	0.035	0.035	0.036	0.037			
30°	0.060	0.060	0.060	0.061			

Note

70

60

50

40

30

20

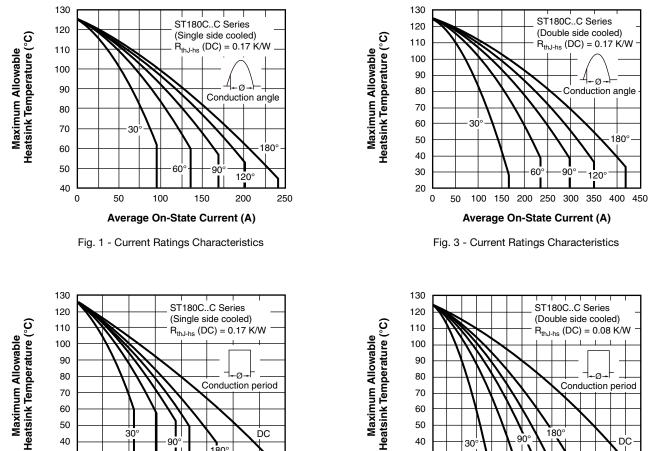
0

30

100

Г

The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC



ĎС

400

180

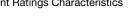
300

120

200

Average On-State Current (A)

Fig. 2 - Current Ratings Characteristics



ø

20

180°

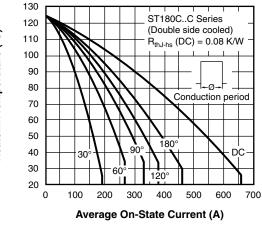
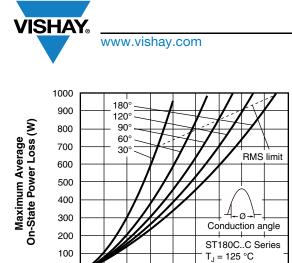


Fig. 4 - Current Ratings Characteristics

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Average On-State Current (A)

200 250 300 350 400 450

Fig. 5 - On-State Power Loss Characteristics

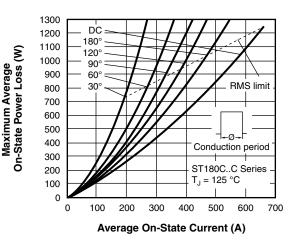
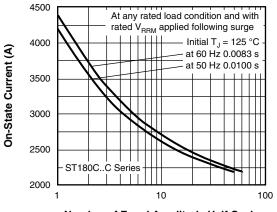


Fig. 6 - On-State Power Loss Characteristics



Peak Half Sine Wave

Number of Equal Amplitude Half Cycle Current Pulses (N)

Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

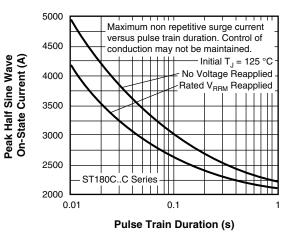
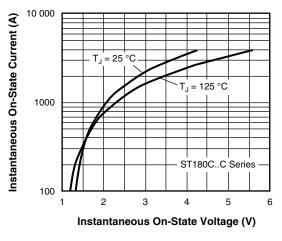
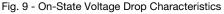
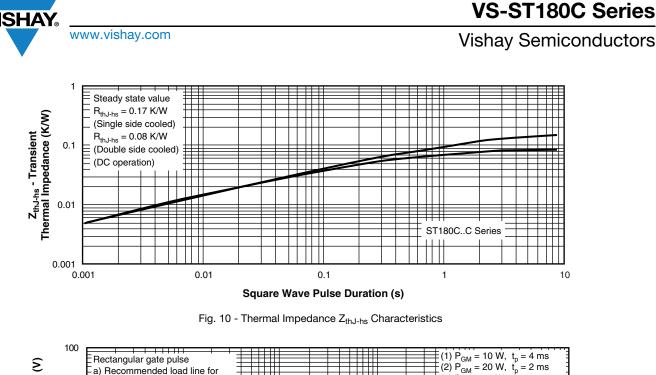


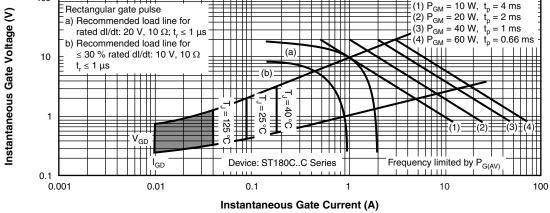
Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

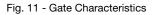




0 50 100 150



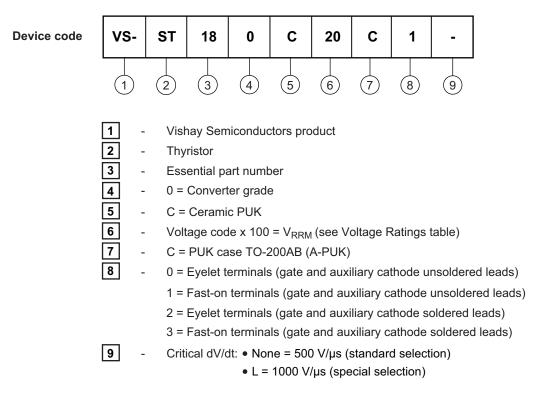




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ORDERING INFORMATION TABLE



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95074			

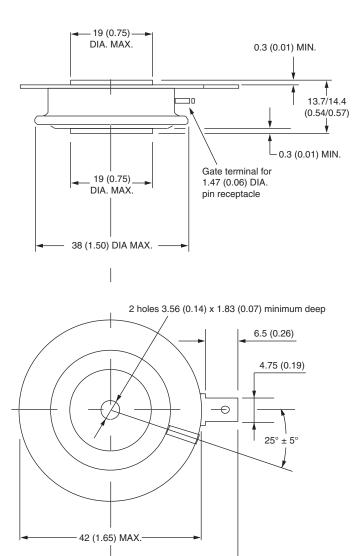


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TO-200AB (A-PUK)

DIMENSIONS in millimeters (inches)

Anode to gate Creepage distance: 7.62 (0.30) minimum Strike distance: 7.12 (0.28) minimum



Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)

28 (1.10)



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